



**National Seminar on
Trends and Innovation in Food Processing Technology:
Prospects and Challenges (TIFPT-2017)**

9-10 February, 2017

Department of Food Engineering & Technology
Tezpur University, Napaam, Tezpur – 784 028, Assam

Application for Sponsorship/ Souvenir Advertisement

Name: _____

Name of the organization: _____

Major area of business/ activity: _____

Address: _____

Email: _____ **Contact No:** _____

Contact person for this purpose: _____

We are interested in supporting the TIFPT 2017 by sponsoring the following activities.

Categories	Fees	Facility	Select
Platinum Sponsor	1,00,000.00	Registration in the conference to 3 delegates of the company Company's presentation (of maximum 15 min) in 2 sessions Exhibition space in the conference Area, Full page colour advertisement in souvenir	
Diamond Sponsor	75,000.00	Registration in the conference to 2 delegates of the company Company's presentation (of maximum 15 min) in 1 sessions Exhibition space in the conference Area, Full page colour advertisement in souvenir	
Gold Sponsor	50,000.00	Registration in the conference to 1 delegates of the company. Exhibition space in the conference Area, Half page colour advertisement in souvenir	
Lunch/ Dinner Sponsor	40,000.00	Display of Banner at Venue, Half page colour advertisement in souvenir	
Inaugural High Tea	30,000.00	Display of Banner at Venue, Half page black and white advertisement in souvenir	
Technical Session Sponsor	20,000.00	Display of Banner at Venue	
Souvenir Advertisement	20,000.00	Half page black and white advertisement in souvenir	
Any other sponsor		Demonstration/presentation at Venue	

Mode of Payment

Payment can be done by Demand Draft/ multicurrency cheque in favour of **REGISTRAR, TEZPUR UNIVERSITY**, Payable at **TEZPUR** or through bank transfer as per following details:

Bank Name	: State Bank of India	Name of Account Holder	: Registrar, Tezpur University
Branch	: Main Branch, Tezpur	Account No.	: 10501585452
IFS Code	: SBIN0000195	MICR Code	: 784002002

Remarks:

Date:

Name:

Signature: